



Information Disclosure Statement

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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-3964 618029-8	U.S. SERIAL NO. 09/768,904
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANT(S) Lap-Wai CHOW, et al.	
	FILING DATE January 24, 2001	GROUP 2815

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE or 102(e) DATE IF APPROPRIATE
JN	3,673,471	6/72	Klein et al.	317	235 R	
	3,946,426	3/76	Sanders	357	71	
	4,017,888	4/77	Christie et al.	357	54	
	4,139,864	2/79	Schulman	358	188	
	4,164,461	8/79	Schilling	204	192 EC	
	4,196,443	4/80	Dingwall	357	68	
	4,267,578	5/81	Vetter	364	709	
	4,291,391	9/81	Chatterjee et al.	365	184	
	4,295,897	10/81	Tubbs et al.	148	1.5	
	4,314,268	2/82	Yoshioka et al.	357	48	
	4,317,273	3/82	Guterman et al.	29	571	
	4,374,454	2/83	Jochems	29	571	
	4,409,434	10/83	Basset et al.	380	265	
	4,435,895	3/84	Parillo	29	571	
	4,471,376	9/84	Morcom et al.	357	71	
	4,581,628	4/86	Miyauchi et al.	357	71	
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		4,821,085	4/89	Haken et al.	357	67	
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		5,065,208	11/91	Shah et al.	357	34	
		5,068,697	11/91	Noda et al.	357	23.5	
		5,070,378	12/91	Yamagata	357	23.5	
		5,101,121	3/92	Sourgen	307	465	
		5,117,276	5/92	Thomas et al.	357	71	
		5,121,089	6/92	Larson et al.	333	107	
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		5,168,340	12/92	Nishimura	357	376	
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EXAMINER	DATE CONSIDERED
JOSEPH NGUYEN	10/31/02

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